

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Kian Teng Eng, et al.

Docket No.: TI-22944.2

Serial No.: TBD

Examiner: TBD

Filed: 1/19/01

Art Unit: TBD

For: VERTICAL BALL GRID ARRAY INTEGRATED CIRCUIT PACKAGE

PRELIMINARY AMENDMENT

Honorable Assistant Commissioner

of Patents

Washington, D.C. 20231

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Date of Deposit: January 19, 2001

Please amend the above referenced Application as follows:

In the Specification:

Page 1, before line 1, insert --This application claims priority under 35 USC §119(e)(1) of Parent Application number 09/115,565 filed 7/14/1998 and Divisional Application number 09/478,917 filed 1/6/2000.--

In the Claims:

Please cancel claims 22-27.

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REMARKS

Entry of the foregoing amendment prior to examinations is respectfully requested.

If the Examiner has any questions or other correspondence regarding this application, Applicant requests that the Examiner contact Applicant's attorney at the below listed telephone number and address.

Respectfully submitted,



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